

Application Data Sheet

Application Information

Application number:: Not Yet Assigned
Application Type:: Utility
Subject Matter:: Utility
Suggested Group Art Unit:: N/A
CD-ROM or CD-R?:: No
Sequence submission?:: No
Computer Readable Form (CRF)?:: No
Title:: Method of Forming a Barrier Metal in a Semiconductor Device
Attorney Docket Number:: 29936/39479
Request for Early Publication?:: No
Request for Non-Publication?:: No
Small Entity?:: No
Petition included?:: No
Secrecy Order in Parent Appl.?:: No

Applicant Information

Applicant Authority Type:: Inventor
Primary Citizenship Country::
Status::
Given Name:: Chang Jin
Family Name:: KO
City of Residence::
Country of Residence:: Republic of Korea
Street of mailing address:: San 136-1, Ami-Ri, Bubal-Uep, Ichon-Shi,
Kyungki-Do
City of mailing address::
Country of mailing address:: Republic of Korea
Postal or Zip Code of mailing address::

Correspondence Information

Correspondence Customer Number:: 04743
Phone number:: (312) 474-6300
Fax number:: (312) 474-0448

Representative Information

Representative Customer Number:: 04743

Domestic Priority Information

Application:: Continuity Type:: Parent Application:: Parent Filing Date::
This Application

Foreign Priority Information

Country::	Application number::	Filing Date::	Priority Claimed::
Republic of Korea	10-2002-0084338	December 26, 2002	

Assignee Information

Assignee name:: Hynix Semiconductor Inc., of San 136-1,
Ami-Ri, Bubal-Uep, Ichon-Shi, Kyungki-Do,
Republic of Korea